





# **EMI/RFI/ESD SHIELDING**

Design, Development and Manufacturing

Made from conductive elastomers, thermoset plastics, metalized fabric, and wire mesh

- Molded Covers/Plate Seals
- Custom Molded Components
- Molded & Stamped Gaskets
- Molded & Spliced Seals
- · End of Arm Tooling/Vacuum Cups
- Reinforced Conductive Elastomer Seals

Registered ISO9001/AS9100 DOD Cleared Facility



800-576-SEAL www.SEALSCIENCE.com

#### **About Us**

SSI's engineered electrically conductive elastomers (conductive rubber) provide sealing solutions for mission critical applications that require both environmental and electromagnetic interference, electrostatic discharge, and radio frequency shielding. The incorporation of elastomers with alloys creates a multi-material compound capable of providing electrical shielding with the superior physical properties of an engineered elastomer. SSI's material engineering team utilizes a variety of elastomeric binders combined with a large array of conductive fillers to custom design solutions for all types of applications in the aerospace, semiconductor, and medical device industries.



Conductive elastomeric seals aid designers by providing a component that can provide both environmental and electric sealing. Proper selection of the elastomeric binder is critical for environmental conditions, and proper selection of the metal filler is critical for galvanic capability to mating surfaces, and corrosion resistance.

SSI provides materials that meet the material properties of MIL-DTL-83528

## **Shielding Theory**

Electrostatic discharge (ESD) shielding is the process of limiting electric current that flows when an excess of electric charge, stored on an electrically insulated object, finds a path to an object at a different electrical potential (such as ground) by separating them with a barrier made of a lightly conductive material. Static dissipative materials have electrical resistance between insulative and conductive materials. There can be electron flow across or through the dissipative material, but it is controlled by the surface resistance or volume resistance of the material.

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Typical materials for ESD shielding in the semiconductor and medical device industries include carbon-filled silicone and polyurethane blends that shield highly sensitive electronic circuitry.

**Electromagnetic interference (EMI)** shielding is the process of blocking the induction of electromagnetic radiation, which is emitted by electrical circuits carrying rapidly changing signals, as a by-product of their normal operation to other circuits which causes unwanted signals (interference or noise). This is achieved by separating the circuits with a barrier made of conductive material.

Radio frequency interference (RFI) shielding is the process blocking radiofrequency electromagnetic radiation from one circuit to another by separating them with a barrier made of conductive material. This is achieved by separating the circuits with a barrier made of conductive material.

Typical solutions for EMI/RFI shielding in the aerospace and medical device industries include gaskets and custom molded seals made from highly conductive elastomers that bridge uneven seams in electronic packaging. Anything other than a 100% metal to metal contact can provide gaps that allow interference to degrade systematic performance.

**Microwave** absorption is the process of absorbing microwave/radar energy at discrete and broadband frequencies by converting the microwave/radar energy into heat. This is achieved by magnetizing an elastomeric material by filling it with a magnetic alloy such as carbonyl iron or ferrite.

Microwave absorbing materials/ radar absorbing materials (RAM) are frequently used in the military industry for radar cross-section (RCS) reduction. Seals designed from microwave absorbing elastomers are effective in reducing both EMI and RCS.

### **Industry Solution**

Aerospace/Military: avionics packaging, enclosure shielding, TEMPEST requirements, radio packaging, canopy/window perimeters, access cover plates, antenna assemblies, composite structure gapping, missile electronics, missile canisters, and RCS reduction.

Semiconductor: semiconductor testing, robotic interfaces, chip handling, circuit shielding, and test equipment packaging.

Medical Equipment: PET, MRI, CAT scanning equipment packaging, display enclosures, panel doors, hand-held devices, and optoelectronics assemblies.

#### **Products**

- Molded and Die Cut Gaskets
- Custom Molded Seals & Shapes
- Molded-in-place seal plates
- O-rings
- D-rings
- Void Cavity Fabric Reinforced Seals
- Flat Washers
- Waveguide Gaskets
- Environmental/EMI Co-molded Seals
- Interfacial Window Seals
- Vacuum Cups
- RAM Seals



POLYMER CHOICE	RESISTANCES						
	High Temp.	Low Temp.	Oil, Fuel, Solvent	Comp. Set	Ozone, Weather	Abrasion Resist.	Flex. Resist.
Silicone	Excellent	Excellent	Poor	Good	Excellent	Fair	Good
Fluorosilicone	Excellent	Excellent	Good	Good	Excellent	Fair	Good
EPDM	Good	Fair	Poor	Fair	Excellent	Good	Good
Polyurethane	Fair	Fair	Good	Fair	Good	Excellent	Good

FILLER CHOICE	COMMENTS				
Carbon	Good for ESD use where lower conductivity is required.				
Nickel Coated Graphite	Good EMI/ESD performance where the environment requires low corrosive reactivity				
Silver Coated Nickel	High Performance in non-corrosive environment				
Silver Coated Aluminum	Excellent EMI/EMP shielding performance in corrosive environments				
Silver Coated Copper	Highest resistance rating for EMP induced current, Excellent for use in non-corrosive environments				
Pure Silver Particles	Highest shielding and conductivity available - For use in a non-corrosive or reactive environment				

